



**EXPEDITED PROCEDURE  
GROUP ART UNIT 2814**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: JEUN et al.

Serial No.: 09/677,558

Title: SEMICONDUCTOR POWER  
MODULE HAVING AN ELECTRICALLY  
INSULATING HEAT SINK AND  
METHOD OF MANUFACTURING THE  
SAME

Filed: September 29, 2000

Group Art Unit: 2814

Examiner: DiLinh Nguyen

Atty. Docket Number: 29347/990488

Customer No.: 04743

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**February 16, 2004**

  
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**AMENDMENT "C" AFTER FINAL REJECTION**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

In response to the final official action dated December 15, 2003 the applicants respectfully request that the application be reconsidered in light of the following amendments and remarks.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Amendments to the Drawings** begin on page 5 of this paper and include an attached replacement sheet.

**Remarks** begin on page 6 of this paper.